JEDEC STANDARD

Embedded MultiMediaCard (e•MMC) Mechanical Standard, with Optional Reset Signal

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Embedded MultiMediaCard (e•MMC) Mechanical Standard, with Optional Reset Signal

Foreword

The Embedded MultiMediaCard (e•MMC) Mechanical Standard has been prepared by JEDEC. The MultiMediaCard Association, hereafter referred to as MMCA, exists to promote adoption of a global standard for a compact, robust, affordable storage and retrieval device, the MultiMediaCard. Consumers worldwide will benefit from this standard, allowing them to carry with them, information and entertainment that fits their needs, wherever they are, whenever they wish.

JEDEC has taken the basic MMCA specification and adopted it for embedded applications, calling it "e•MMC." In addition to the packaging differences, eMMC devices use a reduced voltage interface. These specifications are detailed in the JEDEC Standard for Embedded MultiMediaCard (e•MMC) e•MMC/Card Product Standard, JESD84-Axx.

The purpose of the standard is the mechanical definition of the $e^{\bullet}MMC$.

Introduction

MultiMediaCards are universal data storage and communication media. It is designed to cover a wide area of applications such as smart phones, cameras, organizers, PDAs, digital recorders, MP3 players, pagers, electronic toys, etc. Targeted features are high mobility and high performance at a low cost price. These features include low power consumption and high data throughput at the memory card interface.

MultiMediaCard communication is based on an advanced 11-signal bus. The communication protocol is defined as a part of this standard and referred to as the MultiMediaCard mode.

Embedded MultiMediaCard (e•MMC) Mechanical Standard, with Optional Reset Signal

(From JEDEC Board Ballot JCB-09-26, formulated under the cognizance of the JC-64 Committee on Flash memory modules.)

1 Scope

This standard describes the mechanical features of the $e^{\bullet}MMC$.

2 Normative reference

There are no normative references for this document at this time.

3 Terms and definitions

For the purposes of this publication, the following terms and definitions apply:

MMC: MultiMediaCard

e•MMC: Embedded MultiMediaCard

4 e^{\bullet} MMC General description

The JEDEC e^{\bullet} MMC Mechanical Standard describes the mechanical and physical attributes of the Embedded MultiMediaCard.

There are four physical configurations, AA, AB, AC and BA, that are each discussed in this document.

NOTE As used in this document, "shall" or "will" denotes a mandatory provision of the standard. "Should" denotes a provision that is recommended but not mandatory. "May" denotes a feature whose presence does not preclude compliance, that may or may not be present at the option of the implementor.

4.1 Device signals

JEDEC $e^{\bullet}MMC$ devices transfer data via a configurable number of data-bus signals. The communication signals are shown in Table 1.

Signal	Symbol	Description
Clock	CLK	Each cycle of the clock directs a transfer on the command line and on the data line(s). The frequency can vary between the minimum and the maximum clock frequency.
Command	CMD	This signal is a bidirectional command channel used for device initialization and command transfers. The CMD signal has two operating modes: open-drain for initialization, and push-pull for command transfer. Commands are sent from the MultiMediaCard bus master to the device, and responses are sent from the device to the host.
DATA	DAT[7:0]	These are bidirectional data signals. The DAT signals operate in push-pull mode. By default, after power-up or RESET, only DAT0 is used for data transfer. The memory controller can configure a wider data bus for data transfer using either DAT[3:0] (4-bit mode) or DAT[7:0] (8-bit mode). JEDEC eMMC includes internal pull-up resistors for data lines DAT[7:1]. Immediately after entering the 4-bit mode, the device disconnects the internal pull-up resistors on the DAT1, DAT2, and DAT3. Correspondingly, immediately after entering the 8-bit mode, the device disconnects the internal pull-ups on the DAT1–DAT7.
Reset	RST_n	Reset signal is used for host resetting device, moving the device to pre-idle state. By default, the RST_n signal is temporary disabled in device. Host need to set bit[0:1] in the extended CSD register [162] to 0x1 to enable this functionality before the host uses.

Table 1 — Communication signals

Device initialization uses only the CMD channel and is, therefore, compatible with all devices.

4.2 *e*•MMC Components

Ball assignments for AA, AB and AC devices are depicted in Figure 1 on page 3. Ball assignments for BA devices are shown in Figure 2 on page 4.

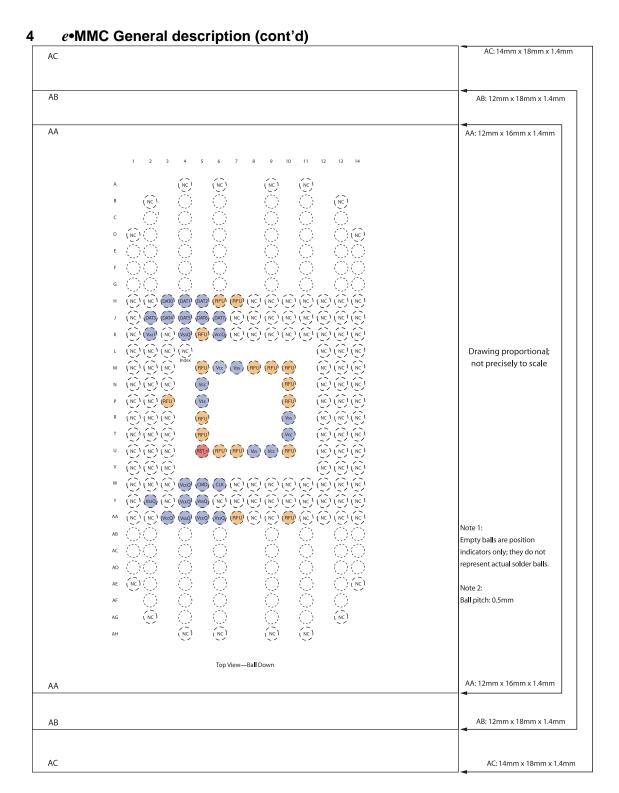


Figure 1 — Ball assignment: AA, AB and AC devices (see MO-276 for details)

NOTE Some previous versions of the specification, either product specification or mechanical specification, had defined reserved ball as NC balls. The NC balls could have been connected to ground in system board. But some of the NC balls could be assigned for new signals in the future. These balls are assigned as RFU in v4.4 mechanical specification. Any new implementations should use the new ball assignments and leave the RFU balls floating on system board.

4 e^{\bullet} MMC General description (cont'd)

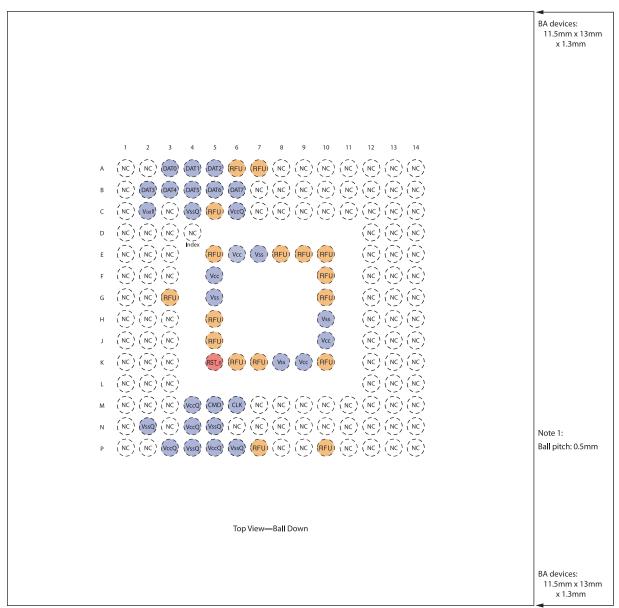


Figure 2 — Ball assignments: BA devices (see MO-276 for details)

NOTE Some previous versions of the specification, either product specification or mechanical specification, had defined reserved ball as NC balls. The NC balls could have been connected to ground in system board. But some of the NC balls could be assigned for new signals in the future. These balls are assigned as RFU in v4.4 mechanical specification. Any new implementations should use the new ball assignments and leave the RFU balls floating on system board.

4.3 e•MMC Physical description

JEDEC *e*•MMC has 11 signals. The host is connected to the device using a dedicated 11-ball connector. Ball assignments are shown in Table 2 on page 5. Note that Table 2 continues on the following page.

4 e^{\bullet} MMC General description (cont'd)

Table 2 — Ball assignments

169-Ball Devices	153-Ball Devices	Symbol	Type	Ball Function	
AA, AB and AC Devices	BA Device				
W6	M6	CLK	Input	Clock: Each cycle directs a 1-bit transfer on the command and DAT lines.	
W5	M5	CMD	Input	Command: A bidirectional channel used for device initialization and command transfers. Command has two operating modes: 1) Open-drain for initialization. 2) Push-pull for fast command transfer.	
Н3	A3	DAT0	I/O	Data I/O0: Bidirectional channel used for data transfer.	
H4	A4	DAT1	I/O	Data I/O1: Bidirectional channel used for data transfer.	
Н5	A5	DAT2	I/O	Data I/O2: Bidirectional channel used for data transfer.	
J2	B2	DAT3	I/O	Data I/O3: Bidirectional channel used for data transfer.	
J3	В3	DAT4	I/O	Data I/O4: Bidirectional channel used for data transfer.	
J4	B4	DAT5	I/O	Data I/O5: Bidirectional channel used for data transfer.	
J5	B5	DAT6	I/O	Data I/O6: Bidirectional channel used for data transfer.	
J6	B6	DAT7	I/O	Data I/O7: Bidirectional channel used for data transfer.	
U5	K5	RST_n	Input	Reset signal pin	
M6, N5, T10, U9	E6, F5, J10, K9	V _{CC}	Supply	V _{CC} : Flash memory I/F and Flash memory power supply.	
K6, W4, Y4, AA3, AA5	C6, M4, N4, P3, P5	V _{CC} Q	Supply	V _{CC} Q: Memory controller core and MMC interface I/O power supply.	
M7, P5, R10, U8	E7, G5, H10, K8	V _{SS}	Supply	V _{SS} : Flash memory I/F and Flash memory ground connection.	
K4, Y2, Y5, AA4, AA6	C4, N2, N5, P4, P6	V _{SS} Q	Supply	V _{SS} Q: Memory controller core and MMC I/F ground connection.	
K2	C2	V _{DD} i		$V_{DD}i$: Connect $0.1\mu F$ capacitor from $V_{DD}i$ to ground.	

Table 2 — Ball assignments (continued)

169-Ball Devices	153-Ball Devices	Symbol	Type	Ball Function				
AA, AB and AC Devices	BA Device							
Miscellaneous								
L4	D4	NC Index	_	Index:				
				Can be connected to ground or left floating.				
A4, A6, A9, A11, B2,	A1, A2, A8, A9, A10,	NC	_	No connect:				
B13, D1, D14, H1,	A11, A12, A13, A14,			Can be connected to ground or left floating.				
H2, H8, H9, H10,	B1, B7, B8, B9, B10,							
H11, H12, H13, H14,	B11, B12, B13, B14,							
J1, J7, J8, J9, J10, J11,	C1, C3, C7, C8, C9,							
J12, J13, J14, K1, K3,	C10, C11, C12, C13,							
K7, K8, K9, K10,	C14, D1, D2, D3,							
K11, K12, K13, K14,	D12, D13, D14, E1,							
L1, L2, L3, L12, L13,	E2, E3, E12, E13,							
L14, M1, M2, M3,	E14, F1, F2, F3, F12,							
M12, M13, M14, N1,	F13, F14, G1, G2,							
N2, N3, N12, N13,	G12, G13, G14, H1,							
N14, P1, P2, P12, P13,	H2, H3, H12, H13,							
P14,	H14, J1, J2, J3, J12,							
R1, R2, R3, R12, R13,	J13, J14, K1, K2, K3,							
R14, T1, T2, T3, T12,	K12, K13, K14, L1,							
T13, T14, U1, U2, U3,	L2, L3, L12, L13,							
U12, U13, U14, V1,	L14, M1, M2, M3,							
V2, V3, V12, V13,	M7, M8, M9, M10,							
V14, W1, W2, W3,	M11, M12, M13,							
W7, W8, W9, W10,	M14, N1, N3, N6, N7,							
W11, W12, W13,	N8, N9, N10, N11,							
W14, Y1, Y3, Y6, Y7,	N12, N13, N14, P1,							
Y8, Y9, Y10, Y11,	P2, P8, P9, P11, P12,							
Y12, Y13, Y14, AA1,	P13, P14							
AA2, AA8, AA9,								
AA11, AA12, AA13,								
AA14, AE1, AE14,								
AG2, AG13, AH4,								
AH6, AH9, AH11								
H6, H7, K5, M5, M8,	A6, A7, C5, E5, E8,	RFU	_	Reserved for future use.				
M9, M10, N10, P3,	E9, E10, F10, G3,			Left it floating for future use.				
P10, R5, T5, U6, U7,	G10, H5, J5, K6, K7,							
U10, AA7, AA10	K10, P7, P10							
010,1111,11110	1110,17,110							





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Standard Improvement Form	JEDEC:	JESD84-C44
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3. Other suggestions for document improvement:		

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